

Special Issue

Smart Systems (SmaSys2019&2020)

Message from the Guest Editors

We are planning to publish a Special Issue on "Smart Systems" related to the International Conference of Smart Systems Engineering (SmaSys2019&2020). The Special Issue on "Smart Systems" provides opportunities for collaboration across a wide range of fields and technologies related to emerging smart systems. Smart systems regard broad scientific and engineering fields. They include organic materials, organic electronics, organic devices, biomaterials, biomedical and biosystem engineering, electrical engineering and informatics, mechanical systems engineering, smart flexible structure and systems, green materials and their processing, tourism engineering with agriculture and foods, and new engineering education. All the participants of SmaSys2019&2020 and their colleagues, especially their students, are encouraged to submit their works to this Special Issue. Dr. Ajit Khosla

Guest Editors

Prof. Dr. Hidemitsu Furukawa

Prof. Dr. Bungo Ochiai

Dr. Masato Makino

Dr. Ajit Khosla

Deadline for manuscript submissions

closed (31 July 2021)



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About the Journal

Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that *Technologies* becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, *Technologies* will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

Editor-in-Chief

Prof. Dr. Manoj Gupta

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